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APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO. CONFIRMATION NO. GR 01 P 0922 10/057,154 01/25/2002 Kurt Gross 2489

> 7590 01/21/2004

LERNER AND GREENBERG, P.A. Post Office Box 2480 Hollywood, FL 33022-2480

EXAMINER WILLIAMS, ALEXANDER O

ART UNIT PAPER NUMBER 2826

DATE MAILED: 01/21/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
Office Action Summan	10/057,154	GROSS ET AL.	
Office Action Summary	Examiner	Art Unit	
	Alexander O Williams	2826	
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	correspondence address	
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a repl If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).  Status	36(a). In no event, however, may a reply be ting ywithin the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE.	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).	
1) Responsive to communication(s) filed on <u>07 N</u>	lovember 2003.		
2a) ☐ This action is <b>FINAL</b> . 2b) ☒ This	action is non-final.		
3) Since this application is in condition for allowa closed in accordance with the practice under E			
Disposition of Claims			
<ul> <li>4)  Claim(s) 1-7 is/are pending in the application.</li> <li>4a) Of the above claim(s) is/are withdrawn from consideration.</li> <li>5)  Claim(s) is/are allowed.</li> <li>6)  Claim(s) 1-4,6 and 7 is/are rejected.</li> <li>7)  Claim(s) 5 is/are objected to.</li> <li>8)  Claim(s) are subject to restriction and/or election requirement.</li> </ul>			
Application Papers	n election requirement.		
9) ☐ The specification is objected to by the Examine 10) ☐ The drawing(s) filed on is/are: a) ☐ acc		Evaminer	
Applicant may not request that any objection to the			
Replacement drawing sheet(s) including the correct		· ·	
11) ☐ The oath or declaration is objected to by the E	kaminer. Note the attached Office	Action or form PTO-152.	
Priority under 35 U.S.C. §§ 119 and 120			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list 13) Acknowledgment is made of a claim for domesti since a specific reference was included in the first 37 CFR 1.78.  a) The translation of the foreign language profits 14) Acknowledgment is made of a claim for domesti reference was included in the first sentence of the	s have been received. s have been received in Application rity documents have been received in Application (PCT Rule 17.2(a)). of the certified copies not received in priority under 35 U.S.C. § 119(a) st sentence of the specification of the covisional application has been received priority under 35 U.S.C. §§ 120	ed in this National Stage ed. e) (to a provisional application) in an Application Data Sheet. eived. and/or 121 since a specific	
Attachment(s)			
Notice of References Cited (PTO-892)  Notice of Draftsperson's Patent Drawing Review (PTO-948)  Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) 🔲 Notice of Informal P	(PTO-413) Paper No(s) latent Application (PTO-152)	
S Patent and Trademark Office			

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Serial Number: 10/057154 Attorney's Docket #: GR01P0922

Filing Date: 1/25/02; claimed foreign priority to 1/25/01

Applicant: Gross et al.

Examiner: Alexander Williams

Applicant's Response, filed 11/7/03 has been acknowledged.

The Declaration filed on 11/7/03 under 37 CFR 1.131 is sufficient to overcome the Huang et al. reference.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains.

Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(f) or (g) prior art under 35 U.S.C. 103(a).

Claims 1, 2 and 7 are rejected under 35 U.S.C. § 103(a) as being unpatentable over Baba (Japan Patent # 58-164232) in view of Kondo et al. (Japan Patent # 63-99557).

For example, in claim 1, Baba et al. (figures 1 to 4) specifically figure 4 show a carrier 27 and a chip 20 configuration, comprising: a carrier 27 having a metal area

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substantially composed of copper; a chip **10** having a rear side metallization layer **25**; a buffer layer **26** configured on said metal area, said buffer layer being substantially composed of nickel; and a connection medium **17** for fixedly connecting said chip to said carrier; said chip being configured, without a chip housing, on said metal area such that only said connecting medium is configured between said rear side metallization layer of said chip and said buffer layer. Baba et al. explicitly fail to show the Ni buffer layer having a thickness between 5 to 10 micrometers.

Kondo et al. is cited for showing a connecting method terminal part and metallic lead in a ceramic substrate. Specifically, Kondo et al. (figures 1 and 2) discloses using a barrier layer 4 consisting of a Ni, a Au layer on a substrate made of ceramic, having the Ni layer having a thickness of about 10 micro-meters for the purpose of reducing content enabling considerable cost savings.

In claim 2, the combination with Kondo et al.'s buffer layer has a thickness between 7 to 9 micrometers.

In claim 7, Kondo et al reference uses carrier includes a plate made of ceramic, said metal area is applied on said plate, and said metal area forms a contact area for said chip.

Therefore, it would be obvious to one of ordinary skill in the art at the time of the invention to use Kondo et al.'s thickness of the Ni layer to modify Baba's Ni layer for the purpose of reducing content enabling considerable cost savings.

Claims 3, 4 and 6 are rejected under 35 U.S.C. § 103(a) as being unpatentable over Baba (Japan Patent # 58-164232) in view of Kondo et al. (Japan Patent # 63-99557) and further in view of Schneegans et al. (U.S. Patent # 5,901,901).

The combination of Baba and Kondo et al. show the features of the claimed invention as detailed above, but fail to explicitly show the rear side metallization layer is substantially composed of aluminum and the carrier is substantially composed of copper.

Schneegans et al. (the figure show the structure, but the prior art discusses the claimed structure) show a carrier and a chip configuration, comprising: a carrier 2 having a metal area essentially composed of copper; a chip 1 having a rear side metallization layer 3 is substantially composed of aluminum; a buffer layer 4 configured on said metal area; and a connection medium 5 for fixedly connecting said chip to said carrier; said chip being configured, without a chip housing, on said metal area such that

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only said connecting medium is configured between said rear side metallization layer of said chip and said buffer layer (see column 1, lines 9-57) for the purpose of reducing content enabling considerable cost savings.

In claims 3 and 4, the combination with Schneegans et al.'s rear side metallization layer **3** is substantially composed of aluminum.

In claim 6, the combination with Schneegans et al.'s uses a carrier that is substantially composed of copper.

Therefore, it would be obvious to one of ordinary skill in the art at the time of the invention to use Schneegans et al.'s rear side metal and copper carrier and Kondo et al.'s thickness of the Ni layer to modify Baba et al.'s device for the purpose of reducing content enabling considerable cost savings.

Claim 5 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

## Response

Applicant's arguments filed 11/7/03 have been fully considered, but are moot in view of the new grounds of rejections detailed above.

Field of Search	Date
U.S. Class and subclass:	8/26/02
257/703,700,701,702,676,765,763,766,769,758,771-	3/7/03
773,762	7/27/03
156/278	1/17/04
Foreign Documentation:	8/26/02
foreign patents and literature in	3/7/03
257/703,700,701,702,676,765,763,766,769,758,771-	7/27/03
773,762	1/17/03
156/278	
Electronic data base(s):	8/26/02
U.S. Patents EAST	3/7/03
	7/27/03
	1/17/04

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Papers related to this application may be submitted to Technology Center 2800 by facsimile transmission. Papers should be faxed to Technology Center 2800 via the Technology Center 2800 Fax center located in Crystal Plaza 4-5B15. The faxing of such papers must conform with the notice published in the Official Gazette, 1096 OG 30 (November 15, 1989). The Technology Center 2800 Fax Center number is (703) 308-7722 or 24. Only Papers related to Technology Center 2800 APPLICATIONS SHOULD BE FAXED to the GROUP 2800 FAX CENTER.

Any inquiry concerning this communication or any earlier communication from the examiner should be directed to *Examiner Alexander Williams* whose telephone number is **(703) 308-4863**.

Any inquiry of a general nature or relating to the status of this application should be directed to the *Technology Center 2800* receptionist whose telephone number is (703) 308-0956.

1/19/04

Primary Examiner Alexander O. Williams